A journey was started four years ago with a series of workshops followed by three successful international symposiums. By June 1999, the IEEE Computer Society approved the formation of the Technical Committee on Wearable Information Systems (TC WIS). TC WIS is now one year old and growing.

In addition to the International Symposium on Wearable Computers (ISWC), TC WIS also co-sponsors the International Workshop on Augmented Reality, which is being held in Munich, Germany this year. We are actively exploring holding ISWC in Europe in the near future.

The TC WIS is devoted to issues concerning the wearing of information based technology on the human body. The TC is concerned with the characteristics of the technology that will be worn, the applications that are appropriate for use on the body, how people interact with wearable information systems, and the ergonomic impact of wearable systems. The TC recognizes that wearable information systems are inherently interdisciplinary and must be addressed in such a manner.

As an interdisciplinary activity, the TC overlaps to some degree with other TCs (Operating Systems, Computer Communications, Distributed Processing, Multimedia, and Security and Privacy) but TC WIS focuses on wearable information systems and the impact of this wearable technology on people.

We welcome you to become a member of the TC WIS. The TC website (http://iswc.gatech.edu) contains instructions on how to join the Technical Committee, information on upcoming Symposia and Workshops, and on-line copies of Proceedings and videos of talks at past symposia.

Please join the TC WIS business meeting associated with the symposium to help plan the future course of your technical community. Also feel free to contact members of the TC organizing committee:

**Chairperson**
Dan Siewiorek, Carnegie Mellon University

**Vice Chairperson**
Alex Pentland, Massachusetts Institute of Technology

**Secretary**
Chris Thompson, Georgia Institute of Technology

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